

Description

The RJK5026DPP can be used in various power swithching circuit for system miniaturization and higher efficiency. The package form is TO-220/TO-220F, which accords with the RoHS standard.

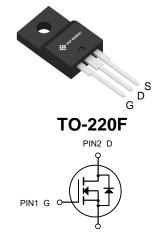
General Features

 $V_{DS} = 500V, I_{D} = 20A$

 $R_{DS(ON)} < 0.3 \Omega@V_{GS}=10V$

Application

• Power switch circuit of adaptor and charger.



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Units Tube
RJK5026DPP	TO-220F	HXY MOSFET	50

Absolute Maximum Ratings@T =25°C(unless otherwise specified)

Symbol	Parameter	Limit	Unit		
V _{DSS}	Drain-to-Source Voltage ^[1]	500	V		
V _{GSS}	Gate-to-Source Voltage	±30			
I _D	Continuous Drain Current	20			
I _{D @ Tc =100°C}	Continuous Drain Current @ Tc=100°C Figure 3		Α		
I _{DM}	Pulsed Drain Current at V _{GS} =10V ^[2]	Figure 6	1		
E _{AS}	Single Pulse Avalanche Energy	1500	mJ		
dv/dt	Peak Diode Recovery dv/dt ^[3]	5.0	V/ns		
P _D	Power Dissipation	165	W		
T _L T _{PAK}	Maximum Temperature for Soldering Leads at 0.063in (1.6mm) from Case for 10 seconds, Package Body for 10 seconds		°C		
T _J & T _{STG}	Operating and Storage Temperature Range	-55 to 150			
R _{θJC}	Thermal Resistance, Junction-to-Case	2.27	9000		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	100	°C/W		

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



Electrical Characteristics (TJ = 25°C unless otherwise specified)

Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions
BV _{DSS}	Drain-to-Source Breakdown Voltage	500	1		V	V _{GS} =0V, I _D =250uA
	Drain-to-Source Leakage Current			1	uA -	V_{DS} =500V, V_{GS} =0V
I _{DSS} [100		V_{DS} =400V, V_{GS} =0V, T_J =125°C
I _{GSS} (Gate-to-Source Leakage Current			+100	nA -	V_{GS} =+30V, V_{DS} =0V
				-100		V _{GS} =-30V, V _{DS} =0V
R _{DS(ON)}	Static Drain-to-Source On-Resistance ^[4]		0.26	0.3	Ω	V _{GS} =10V, I _D =10A
V _{GS(TH)}	Gate Threshold Voltage	2.0		4.0	V	$V_{DS}=V_{GS}$, $I_{D}=250uA$
gfs	Forward Transconductance ^[4]		17		S	VDS=15V,ID=10A
C _{iss}	Input Capacitance		2864			V_{GS} =0V, V_{DS} =25V, f =1.0MH $_{Z}$
C _{rss}	Reverse Transfer Capacitance		25		pF	
C _{oss}	Output Capacitance		286			
Qg	Total Gate Charge		63			V_{DD} =250V, I_{D} =20A, V_{GS} =0 to 10V
Q _{gs}	Gate-to-Source Charge		14		nC	
Q _{gd}	Gate-to-Drain (Miller) Charge		24			
td(ON)	Turn-on Delay Time		33			V_{DD} =250V, I_{D} =20A, V_{GS} = 10V R_{G} =25 Ω
trise	Rise Time		75			
td(OFF)	Turn-Off Delay Time		181		nS	
t fall	Fall Time		83			
I _{SD}	Continuous Source Current ^[4]			20	^	Integral PN-diode in MOSFET
I _{SM}	Pulsed Source Current ^[4]			80	Α	
V _{SD}	Diode Forward Voltage			1.5	V	I _S =20A, V _{GS} =0V
trr	Reverse recovery time		392		V	V_{GS} =0 V , IF=20 A ,
Qrr	Reverse recovery charge	very charge 3.3		uC	diғ/dt=100A/μs	

Note:

^[1] T_J=+25°C to +150°C

^[2] Repetitive rating; pulse width limited by maximum junction temperature.

^[3] ISD= 20A di/dt < 100 A/μs, VDD < BVDSS, TJ=+150°C. [4] Pulse width≤380μs; duty cycle≤2%.



Typical Characteristics

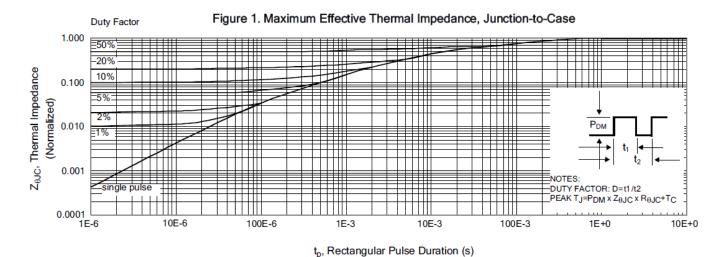


Figure 2. Maximum Power Dissipation vs Case Temperature

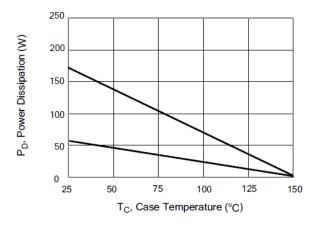


Figure 4. Typical Output Characteristics

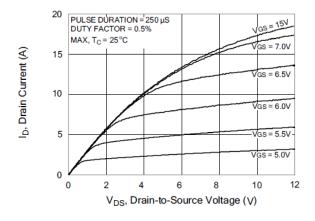


Figure 3. Maximum Continuous Drain Current vs Case Temperature

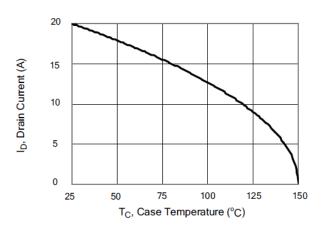
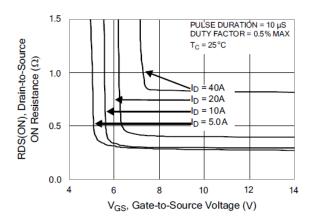


Figure 5. Typical Drain-to-Source ON Resistance vs Gate Voltage and Drain Current



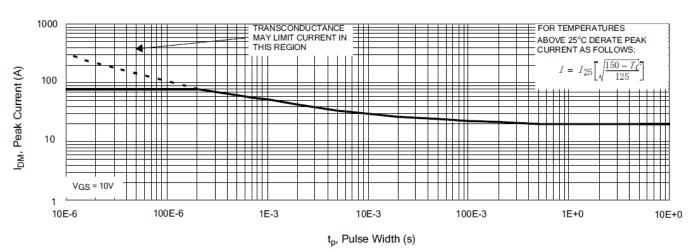


Figure 6. Maximum Peak Current Capability

Figure 7. Typical Transfer Characteristics

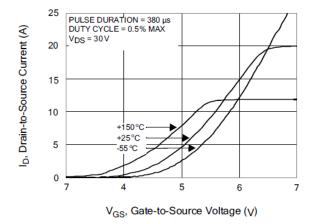


Figure 9. Typical Drain-to-Source ON Resistance vs Drain Current

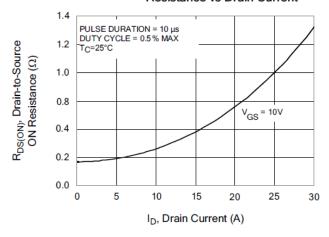


Figure 8. Unclamped Inductive Switching Capability

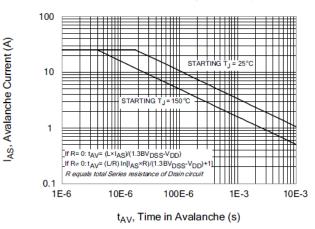
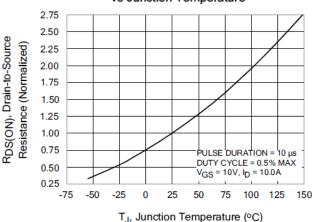
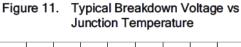


Figure 10. Typical Drain-to-Source ON Resistance vs Junction Temperature





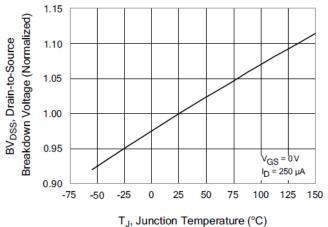
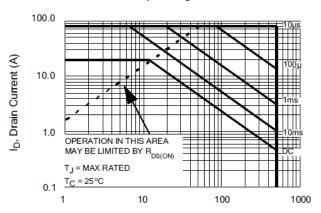


Figure 13. Maximum Forward Bias Safe Operating Area



V_{DS}, Drain-to-Source Voltage (V)

Figure 15. Typical Gate Charge vs Gate-to-Source Voltage

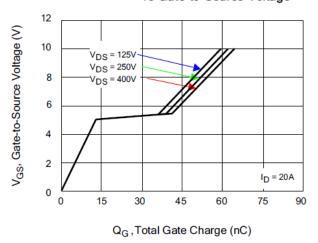


Figure 12. Typical Threshold Voltage vs Junction Temperature

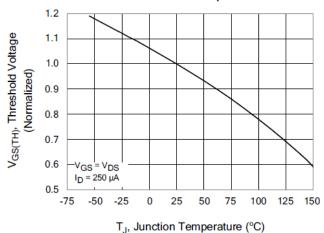


Figure 14. Typical Capacitance vs Drain-to-Source Voltage

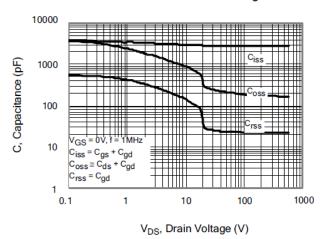
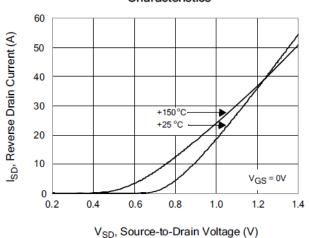
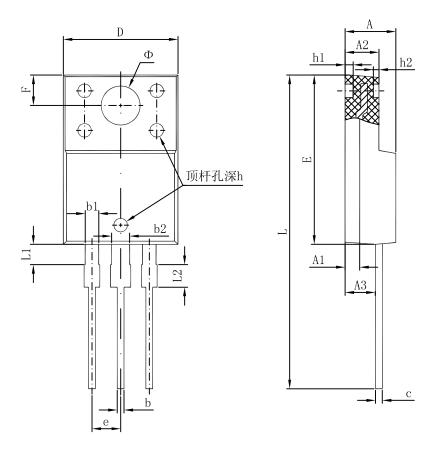


Figure 16. Typical Body Diode Transfer Characteristics





Package Dimension TO-220F



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.300	4.700	0.169	0.185	
A1	1.300	REF.	0.051 REF.		
A2	2.800	3.200	0.110	0.126	
A3	2.500	2.900	0.098	0.114	
b	0.500	0.750	0.020	0.030	
b1	1.100	1.350	0.043	0.053	
b2	1.500	1.750	0.059	0.069	
С	0.500	0.750	0.020	0.030	
D	9.960	10.360	0.392	0.408	
Е	14.800	15.200	0.583	0.598	
е	2.540 TYP.		0.100 TYP.		
F	2.700 REF.		0.106 REF.		
Φ	3.500 REF.		0.138 REF.		
h	0.000	0.300	0.000	0.012	
h1	0.800 REF.		0.031 REF.		
h2	0.500 REF.		0.020 REF.		
L	28.000	28.400	1.102	1.118	
L1	1.700	1.900	0.067	0.075	
L2	1.900	2.100	0.075	0.083	



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